P-1

LTC8825, LTC8826, LTC8828 Micropower 500kHz, Precision, 1.8V, RRIO CMOS Amplifiers

General Description

The LTC882x family of single-, dual-, and quad- channel amplifiers provides input offset voltage correction for low offset (maximum 350 μ V) and drift (typically 0.8 μ V/°C) through the use of proprietary techniques. Featuring rail-to-rail input and output swings, and low quiescent current (typical 15 μ A at 5V supply) combined with a wide bandwidth of 500 kHz and very low noise (6 $\mu V_{P_{P}P}$ at 0.1 to 10 Hz) makes this family very attractive for a variety of battery-powered applications such as wearables, tablets, and portable medical devices. The low input bias current supports these amplifiers to be used in applications with mega-ohm source impedances.

The robust design of the LTC882x operational amplifiers provides ease-of-use to the circuit designer: integrated RF/EMI rejection filter, no phase reversal in overdrive conditions, and high electro-static discharge (ESD) protection (5-kV HBM and 2-kV CDM). The LTC882x amplifiers are optimized for operation at voltages as low as +1.8 V (\pm 0.9 V) and up to +5.5 V (\pm 2.75 V).

The LTC8825/8827 (single) is available in both SOT23-5L and SC70-5L packages. The LTC8826 (dual) is offered in DFN-8L, SOIC-8L and MSOP-8L packages. The guadchannel LTC8828 is offered in both SOIC-14L and TSSOP-14L packages. All of the devices are specified over the extended temperature range of -40 °C to +125 °C.

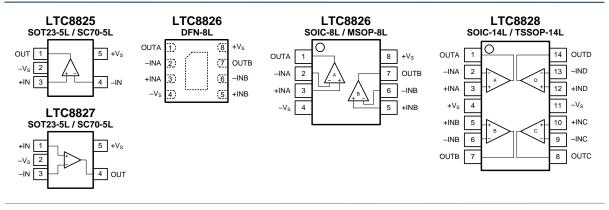
Features and Benefits

- 500 kHz GBW
- Micro-power 15 µA Supply Current (at 5V Supply, Per Amplifier)
- Low Input Offset Voltage: \pm 350 μ V Maximum
- Low Noise: 6 μ V_{P-P} at 0.1 to 10 Hz
- Single 1.8 V to 5.5 V Supply Voltage Range
- Rail-to-Rail Input and Output
- Internal RF/EMI Filter
- Extended Temperature Range: -40°C to +125°C

Applications

- **Battery-Powered Instruments:** Consumer, Industrial, Medical, Notebooks
- Wearable Fitness Devices
- Audio Outputs
- Sensor Signal Conditioning:
 - Sensor Interfaces, Loop-Powered, Active Filters
- Wireless Sensors: Home Security, Remote Sensing, Wireless Metering

Pin Configurations (Top View)



İNEARIN

CAUTION: These devices are sensitive to electrostatic discharge: follow proper IC Handling Procedures Linearin and designs are registered trademarks of Linearin Technology Corporation.

© Copyright Linearin Technology Corporation. All Rights Reserved.

P-2

Pin Description

Symbol	Description
-IN	Inverting input of the amplifier.
+IN	Non-inverting input of the amplifier.
+V _s	Positive (highest) power supply.
-V _s	Negative (lowest) power supply.
OUT	Amplifier output.

Ordering Information

Type Number	Package Name	Package Quantity	Marking Code ⁽¹⁾
LTC8825XT5/R6	S0T23-5L	Tape and Reel, 3 000	AL1xxx
LTC8825XC5/R6	SC70-5L	Tape and Reel, 3 000	AL1xxx
LTC8826XF8/R6	DFN2x2-8L	Tape and Reel, 3 000	AL2
LTC8826XS8/R8	SOIC-8L	Tape and Reel, 4 000	AL2IX
LTC8826XV8/R6	MSOP-8L	Tape and Reel, 3 000	AL2I
LTC8827XT5/R6	S0T23-5L	Tape and Reel, 3 000	AL3xxx
LTC8827XC5/R6	SC70-5L	Tape and Reel, 3 000	AL3xxx
LTC8828XS14/R5	SOIC-14L	Tape and Reel, 2 500	AL4IX
LTC8828XT14/R6	TSSOP-14L	Tape and Reel, 3 000	AL4IX

(1) There may be multiple device markings, a varied marking character of "x", or additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

Limiting Value

In accordance with the Absolute Maximum Rating System (IEC 60134).

Parameter	Absolute Maximum Rating
Supply Voltage, V_{S+} to V_{S-}	10.0 V
Signal Input Terminals: Voltage, Current	$\rm V_{S_{\text{-}}}$ – 0.3 V to $\rm V_{S^{\star}}$ + 0.3 V, $\pm 10~mA$
Output Short-Circuit	Continuous
Storage Temperature Range, T _{stg}	–65 ℃ to +150 ℃
Junction Temperature, T _J	150 ℃
Lead Temperature Range (Soldering 10 sec)	260 ℃

ESD Rating

Parameter	Item	Value	Unit
Electrostatic Discharge Voltage	Human body model (HBM), per MIL-STD-883J / Method 3015.9 ⁽¹⁾	\pm 5 000	
	Charged device model (CDM), per ESDA/JEDEC JS-002-2014 ⁽²⁾	\pm 2 000	v
	Machine model (MM), per JESD22-A115C	\pm 250	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures.

© Copyright Linearin Technology Corporation. All Rights Reserved.



NEARIN

Electrical Characteristics

P-3

 $V_S = 5.0V$, $T_A = +25^{\circ}C$, $V_{CM} = V_S/2$, $V_0 = V_S/2$, and $R_L = 10k\Omega$ connected to $V_S/2$, unless otherwise noted. Boldface limits apply over the specified temperature range, $T_A = -40$ to +125 °C.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
OFFSET	VOLTAGE						
		LTC8825, LTC8826		±100	±350	.,	
V _{os}	Input offset voltage	LTC8828		±120	±500	– μV	
V _{os} TC	Offset voltage drift	T _A = −40 to +125 °C		±0.8	±2.3	μV/°C	
	Power supply	$\rm V_{S}$ = 2.0 to 5.5 V, $\rm V_{CM}$ < $\rm V_{S+}$ – 2V	98	115		ЧD	
PSRR	rejection ratio	T _A = −40 to +125 °C	88			– dB	
INPUT BI	AS CURRENT						
				1		_	
Input bias currei	Input bias current	T _A = +85 °C		150		pА	
		T _A = +125 °C		500		-	
I _{os}	Input offset current			1		pА	
NOISE							
V _n	Input voltage noise	f = 0.1 to 10 Hz		6		μV_{P-P}	
e _n Input voltage noise density	f = 10 kHz		62				
	f = 1 kHz		63		– nV/√Hz		
I _n	Input current noise density	f = 1 kHz		5		fA/√Hz	
INPUT VC							
., Common-mode			V _{s-} -0.1		V _{S+} +0.1		
Vall	voltage range	T₄ = −40 to +125 °C	V _{s-}		V _{s+} -0.1	– V	
		V _{CM} = 0 to 4.0 V	86	102			
	Common-mode	V _{CM} = 0 to 4.0 V, T _A = -40 to +125 °C	80			— — dB	
CMRR	rejection ratio	V _S = 2.0 V, V _{CM} = 0 to 1.0 V	82	95			
		V_{CM} = 0 to 1.8 V, T_A = -40 to +125 °C	77			_	
INPUT IM	IPEDANCE						
R _{IN}	Input resistance		100			GΩ	
		Differential		2.0			
C _{IN}	Input capacitance	Common mode		3.5		– pF	
OPEN-LO	OOP GAIN						
		R _L = 25 kΩ, V ₀ = 0.05 to 3.5 V	106	118			
	Open-loop voltage	T _A = −40 to +125 °C	100				
A _{VOL}	gain	R _L = 5 kΩ, V ₀ = 0.15 to 3.5 V	100	112		– dB	
		T _A = −40 to +125 °C	94			_	
FREQUEI	NCY RESPONSE						
	Gain bandwidth			500		kHz	
GBW		G = +1, C ₁ = 100 pF, V ₀ = 1.5 to 3.5 V		500 0.25		kHz V/μs	
GBW SR	Gain bandwidth product Slew rate Total harmonic	G = +1, f = 1 kHz, R _L = 2 kΩ,					
<i>FREQUEI</i> GBW SR THD+N	Gain bandwidth product Slew rate			0.25		V/µs	



© Copyright Linearin Technology Corporation. All Rights Reserved. All other trademarks mentioned are the property of their respective owners.

Electrical Characteristics (continued)

 $V_s = 5.0V$, $T_A = +25^{\circ}$ C, $V_{CM} = V_s/2$, $V_o = V_s/2$, and $R_L = 10k\Omega$ connected to $V_s/2$, unless otherwise noted. Boldface limits apply over the specified temperature range, $T_A = -40$ to +125 °C.

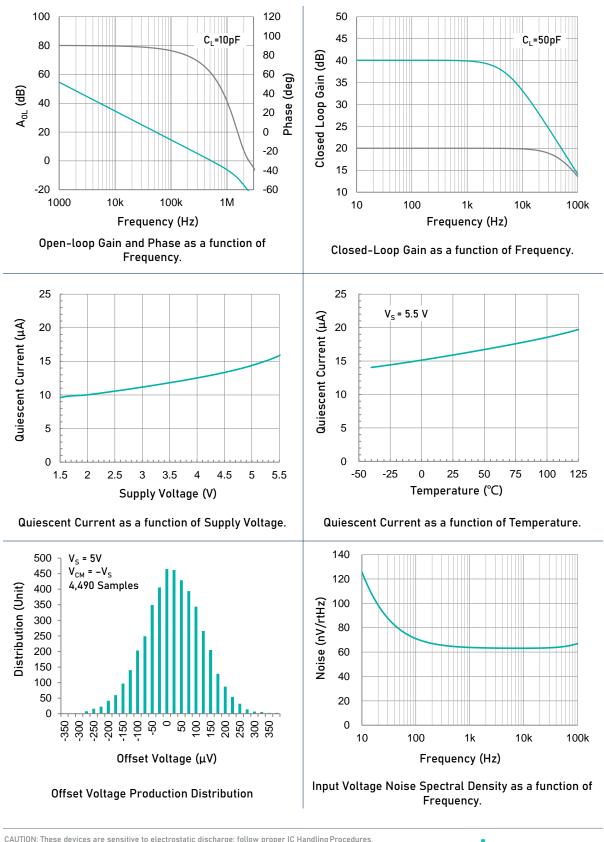
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
t _{or}	Overload recovery time	To 0.1%, V _{IN} * Gain > V _S		10		μs	
OUTPUT							
V	High output voltage	R _L = 25 kΩ	V _{S+} -8	V _{S+} -5		- mV	
V _{OH}	swing	R _L = 5 kΩ	V _{S+} -36	V _{S+} -26		- 111V	
V	Low output voltage	R _L = 25 kΩ		V _{S-} +4	V _{S-} +6	- m\/	
V _{OL}	swing	R _L = 5 kΩ		V _{S-} +16	V _{S-} +24	- mV	
I _{SC}	Short-circuit current			±45		mA	
POWER S	UPPLY						
Vs	Operating supply voltage		1.8		5.5	V	
	Quiescent current	V _S = 1.8V, T _A = +25°C		9	12		
Ι _Q	(per amplifier)	V _S = 5.0V, T _A = +25°C		15	19	— μΑ	
THERMAL	CHARACTERISTICS						
T _A	Operating temperature range		-40		+125	°C	
		SC70-5L		333			
		SOT23-5L		190		-	
		DFN2x2-8L 80			-		
θ _{JA}	Package Thermal Resistance	MSOP-8L		216		°C/W	
		SOIC-8L 125			-		
		TSS0P-14L	112			-	
		SOIC-14L		115		-	



Typical Performance Characteristics

P-5

At $T_A = +25^{\circ}C$, $V_{CM} = V_S/2$, and $R_L = 10k\Omega$ connected to $V_S/2$, unless otherwise noted.





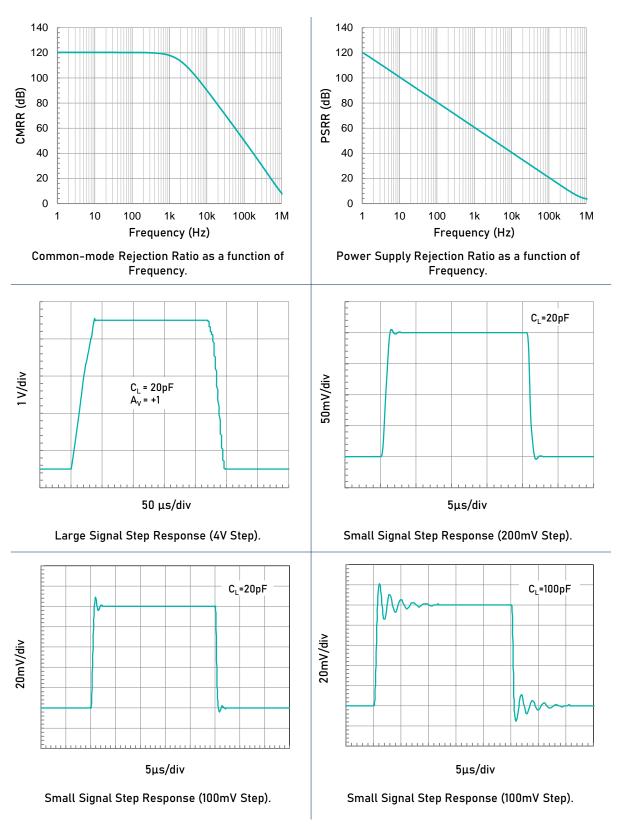
Linearin and designs are registered trademarks of Linearin Technology Corporation. © Copyright Linearin Technology Corporation. All Rights Reserved. All other trademarks mentioned are the property of their respective owners.

INEARIN

Typical Performance Characteristics (continued)

P-6

At $T_A = +25^{\circ}C$, $V_{CM} = V_S/2$, and $R_L = 10k\Omega$ connected to $V_S/2$, unless otherwise noted.

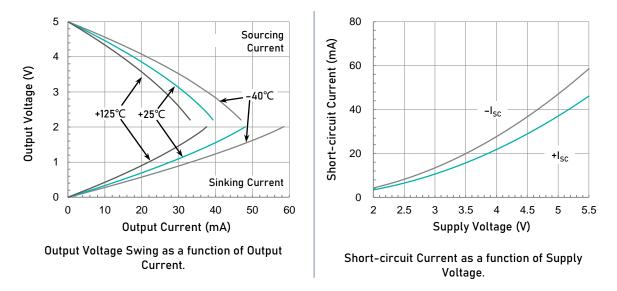


CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. Linearin and designs are registered trademarks of Linearin Technology Corporation.

© Copyright Linearin Technology Corporation. All Rights Reserved. All other trademarks mentioned are the property of their respective owners.

Typical Performance Characteristics (continued)

At $T_A = +25^{\circ}C$, $V_{CM} = V_S/2$, and $R_L = 10k\Omega$ connected to $V_S/2$, unless otherwise noted.





P-8

Application Notes

Featuring a maximized ratio of GBW-to-supply current, precision, low supply voltage, low input bias current, and rail-to-rail inputs and outputs, the LTC882x family is an excellent choice for precision general-purpose, low-current, low-voltage, or battery-powered applications. These CMOS operational amplifiers consume an ultra-low 15-µA (typically at 5-V supply voltage) supply current per amplifier. The LTC882x family is unity-gain stable with a 500-kHz GBW product, driving capacitive loads up to 20-pF. The capacitive load can be increased to 500-pF when the amplifier is configured for a 5-V/V gain.

OPERATING VOLTAGE

The LTC882x family is optimized for operation at voltages as low as +1.8 V (\pm 0.9 V) and up to +5.5 V (\pm 2.75 V). In addition, many specifications apply from -40 °C to +125 °C. Parameters that vary significantly with operating voltages or temperature are illustrated in the Typical Characteristics graphs.

RAIL-TO-RAIL INPUT

The input common-mode voltage range of the LTC882x series extends 100-mV beyond the negative and positive supply rails. This performance is achieved with a complementary input stage: an Nchannel input differential pair in parallel with a Pchannel differential pair. The N-channel pair is active for input voltages close to the positive rail, typically V_{S+} -1.4 V to the positive supply, whereas the Pchannel pair is active for inputs from 100-mV below the negative supply to approximately V_{S+}-1.4 V. There is a small transition region, typically V_{S+} -1.2 V to V_{S+} -1 V, in which both pairs are on. This 200-mV transition region can vary up to 200-mV with process variation. Thus, the transition region (both stages on) can range from V_{S+} -1.4 V to V_{S+} -1.2 V on the low end, up to V_{S+} -1 V to V_{S+} -0.8 V on the high end. Within this transition region, PSRR, CMRR, offset voltage, offset drift, and THD can be degraded compared to device operation outside this region.

The typical input bias current of the LTC882x opamps during normal operation is approximately 1-pA. In overdriven conditions, the bias current can increase significantly. The most common cause of an overdriven condition occurs when the operational amplifier is outside of the linear range of operation. When the output of the operational amplifier is driven to one of the supply rails, the feedback loop requirements cannot be satisfied and a differential input voltage develops across the input pins. This differential input voltage results in activation of parasitic diodes inside the front-end input chopping switches that combine with electromagnetic interference (EMI) filter resistors to create the equivalent circuit. Notice that the input bias current remains within specification in the linear region.

INPUT EMI FILTER AND CLAMP CIRCUIT

Figure 1 shows the input EMI filter and clamp circuit. The LTC882x op-amps have internal ESD protection diodes (D1, D2, D3, and D4) that are connected between the inputs and each supply rail. These diodes protect the input transistors in the event of electrostatic discharge and are reverse biased during normal operation. This protection scheme allows voltages as high as approximately 300-mV beyond the rails to be applied at the input of either terminal without causing permanent damage. These ESD protection current-steering diodes also provide in-circuit, input overdrive protection, as long as the current is limited to 10-mA as stated in the Absolute Maximum Ratings.

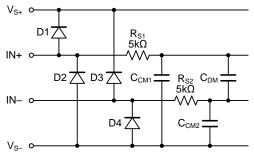


Figure 1. Input EMI Filter and Clamp Circuit

Operational amplifiers vary in susceptibility to EMI. If conducted EMI enters the operational amplifier, the dc offset at the amplifier output can shift from its nominal value when EMI is present. This shift is a result of signal rectification associated with the internal semiconductor junctions. Although all operational amplifier pin functions can be affected by EMI, the input pins are likely to be the most susceptible. The EMI filter of the LTC882x family is composed of two 5-k Ω input series resistors (R_{S1} and R_{S2}), two common-mode capacitors (C_{CM1} and C_{CM2}), and a differential capacitor (C_{DM}). These RC networks set the -3 dB low-pass cutoff frequencies at 35-MHz for common-mode signals, and at 22-MHz for differential signals.

RAIL-TO-RAIL OUTPUT

Designed as a micro-power, low-noise operational amplifier, the LTC882x delivers a robust output drive capability. A class AB output stage with commonsource transistors is used to achieve full rail-to-rail output swing capability. For resistive loads up to 25-k Ω , the output swings typically to within 5 mV of either supply rail regardless of the power-supply voltage applied. Different load conditions change the ability of the amplifier to swing close to the rails. For resistive loads up to 5-k Ω , the output swings typically to within 26-mV of the positive supply rail and within 16-mV of the negative supply rail.



CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. Linearin and designs are registered trademarks of Linearin Technology Corporation.

[©] Copyright Linearin Technology Corporation. All Rights Reserved.

Application Notes (continued)

CAPACITIVE LOAD AND STABILITY

The LTC882x family of operational amplifiers is unity-gain stable for loads up to 20-pF. However, the capacitive load can be increased to 500-pF when the amplifier is configured for a minimum gain of 5-V/V.

As with most amplifiers, driving larger capacitive loads than specified may cause excessive overshoot and ringing, or even oscillation. A heavy capacitive load reduces the phase margin and causes the amplifier frequency response to peak. Peaking corresponds to overshooting or ringing in the time domain. Therefore, it is recommended that external compensation be used if the LTC882x family requires greater capacitive-drive capability. This compensation is particularly important in the unitygain configuration, which is the worst case for stability.

A quick and easy way to stabilize the op-amp for capacitive load drive is by adding a series resistor, R_{ISO} , between the amplifier output terminal and the load capacitance, as shown in Figure 2. R_{ISO} isolates the amplifier output and feedback network from the capacitive load. The bigger the R_{ISO} resistor value, the more stable V_{OUT} will be. Note that this method results in a loss of gain accuracy because R_{ISO} forms a voltage divider with the R_L . In unity gain applications with relatively small R_L (approximately 5-k Ω), the capacitive load can be increased up to 100-pF.

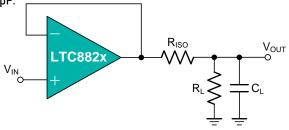


Figure 2. Indirectly Driving Heavy Capacitive Load

An improvement circuit is shown in Figure 3. It provides DC accuracy as well as AC stability. The R_F provides the DC accuracy by connecting the inverting signal with the output.

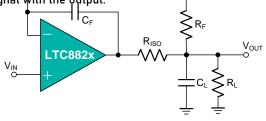


Figure 3. Indirectly Driving Heavy Capacitive Load with DC Accuracy

The C_F and R_{ISO} serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier's inverting input, thereby preserving phase margin in the overall feedback loop.

For no-buffer configuration, there are two others ways to increase the phase margin: (a) by increasing the amplifier's gain, or (b) by placing a capacitor in parallel with the feedback resistor to counteract the parasitic capacitance associated with inverting node.

OVERLOAD RECOVERY

Overload recovery is defined as the time required for the operational amplifier output to recover from a saturated state to a linear state. The output devices of the operational amplifier enter a saturation region when the output voltage exceeds the rated operating voltage, either because of the high input voltage or the high gain. After the device enters the saturation region, the charge carriers in the output devices require time to return back to the linear state. After the charge carriers return back to the linear state, the device begins to slew at the specified slew rate. Thus, the propagation delay in case of an overload condition is the sum of the overload recovery time and the slew time. The overload recovery time for the LTC882x family is approximately 10-µs.

EMI REJECTION RATIO

Circuit performance is often adversely affected by high frequency EMI. When the signal strength is low and transmission lines are long, an op-amp must accurately amplify the input signals. However, all opamp pins — the non-inverting input, inverting input, positive supply, negative supply, and output pins are susceptible to EMI signals. These high frequency signals are coupled into an op-amp by various means, such as conduction, near field radiation, or far field radiation. For example, wires and printed circuit board (PCB) traces can act as antennas and pick up high frequency EMI signals.

Amplifiers do not amplify EMI or RF signals due to their relatively low bandwidth. However, due to the nonlinearities of the input devices, op-amps can rectify these out of band signals. When these high frequency signals are rectified, they appear as a dc offset at the output.

The LTC882x op-amps have integrated EMI filters at their input stage. A mathematical method of measuring EMIRR is defined as follows:

EMIRR = 20 log (
$$V_{IN_{PEAK}} / \Delta V_{OS}$$
)

INPUT-TO-OUTPUT COUPLING

To minimize capacitive coupling, the input and output signal traces should not be parallel. This helps reduce

CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. Linearin and designs are registered trademarks of Linearin Technology Corporation. © Copyright Linearin Technology Corporation. All Rights Reserved.





Application Notes (continued)

unwanted positive feedback.

MAXIMIZING PERFORMANCE THROUGH PROPER LAYOUT

To achieve the maximum performance of the extremely high input impedance and low offset voltage of the LTC882x op-amps, care is needed in laying out the circuit board. The PCB surface must remain clean and free of moisture to avoid leakage currents between adjacent traces. Surface coating of the circuit board reduces surface moisture and provides a humidity barrier, reducing parasitic resistance on the board. The use of guard rings around the amplifier inputs further reduces leakage currents. Figure 4 shows proper guard ring configuration and the top view of a surface-mount layout. The guard ring does not need to be a specific width, but it should form a continuous loop around both inputs. By setting the guard ring voltage equal to the voltage at the non-inverting input, parasitic capacitance is minimized as well. For further reduction of leakage currents, components can be mounted to the PCB using Teflon standoff insulators.

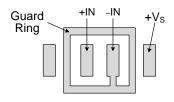


Figure 4. Use a guard ring around sensitive pins

Other potential sources of offset error are thermoelectric voltages on the circuit board. This voltage, also called Seebeck voltage, occurs at the junction of two dissimilar metals and is proportional to the temperature of the junction. The most common metallic junctions on a circuit board are solder-toboard trace and solder-to-component lead. If the temperature of the PCB at one end of the component is different from the temperature at the other end, the resulting Seebeck voltages are not equal, resulting in a thermal voltage error.

This thermocouple error can be reduced by using dummy components to match the thermoelectric error source. Placing the dummy component as close as possible to its partner ensures both Seebeck voltages are equal, thus canceling the thermocouple error. Maintaining a constant ambient temperature on the circuit board further reduces this error. The use of a ground plane helps distribute heat throughout the board and reduces EMI noise pickup.



Typical Application Circuits

DIFFERENTIAL AMPLIFIER

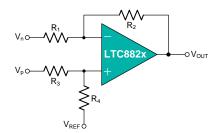


Figure 5. Differential Amplifier

The circuit shown in Figure 5 performs the difference function. If the resistors ratios are equal $R_4/R_3 = R_2/R_1$, then:

$$V_{OUT} = (V_p - V_n) \times R_2/R_1 + V_{REF}$$

INSTRUMENTATION AMPLIFIER

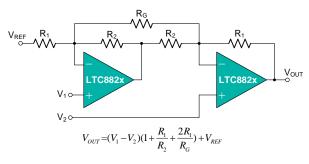


Figure 6. Instrumentation Amplifier

The LTC882x family is well suited for conditioning sensor signals in battery-powered applications. Figure 6 shows a two op-amp instrumentation amplifier, using the LTC882x op-amps. The circuit works well for applications requiring rejection of common-mode noise at higher gains. The reference voltage (V_{REF}) is supplied by a low-impedance source. In single voltage supply applications, the V_{REF} is typically $V_{S}/2$.

BATTERY MONITORING

The low operating voltage and quiescent current of the LTC882x family make it an excellent choice for battery monitoring applications, as shown in Figure 7. In this circuit, V_{STATUS} is high as long as the battery voltage remains above 2-V (V_{REF} = 1.2V). A low-power reference is used to set the trip point. Resistor values are selected as follows:

- 1. R_F Selecting: Select R_F such that the current through R_F is approximately 1000x larger than the maximum bias current over temperature: R_F = V_{REF} \div (1000×I_{BMAX}) = 1.2V \div (1000×100pA) = 12M $\Omega \approx 10M\Omega$
- 2. Choose the hysteresis voltage, $V_{\rm HYST}$. For battery

monitoring applications, 50-mV is adequate.

- 3. Calculate R₁ as follows: $R_1 = R_F \times (V_{HYST} \div V_{BATT}) \approx 10M\Omega \times (50mV \div 2.4V) = 210k\Omega$
- 4. Select a threshold voltage for V_{IN} rising $(V_{TS}) = 2.0V$.
- 5. Calculate R_2 as follows: $R_2 = 1 \div [V_{TS} \div (V_{REF} \times R_1) - 1 \div R_1 - 1 \div R_F] =$ $1 \div [2V \div (1.2V \times 210k\Omega) - 1 \div 210k\Omega - 1 \div 10M\Omega]$ $= 325k\Omega$
- 6. Calculate R_{BIAS}: The minimum supply voltage for this circuit is 1.8V. Providing 9µA of supply current assures proper operation. Therefore: $R_{BIAS} = (V_{BATTMIN} - V_{REF}) \div I_{BIAS} = (1.8V - 1.2V) \div 9µA = 67k\Omega$

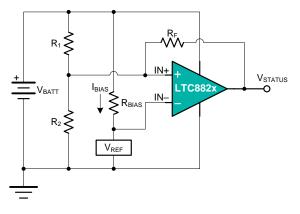
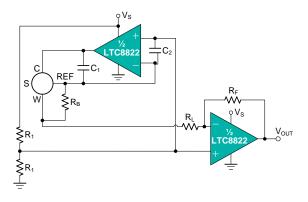


Figure 7. Battery Monitor

PORTABLE GAS METER





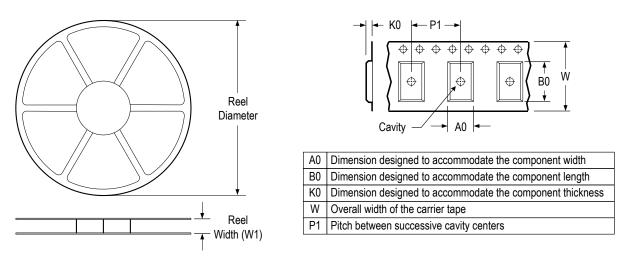




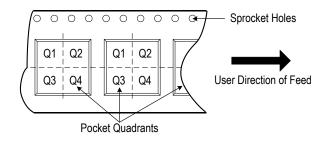
LTC8825, LTC8826, LTC8828 Micropower 500kHz, Precision, 1.8V, RRIO CMOS Amplifiers

Tape and Reel Information

REEL DIMENSIONS



QUADRANT ASSIGNMENTS FOR PIN 1 ORIETATION IN TAPE



* All dimensions are nominal

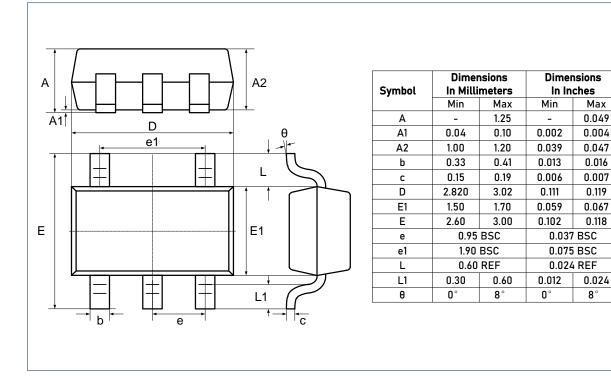
Device	Package Type	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin 1 Quadrant
LTC8825XT5/R6	SOT23	5	3 000	178	9.0	3.3	3.2	1.5	4.0	8.0	Q3



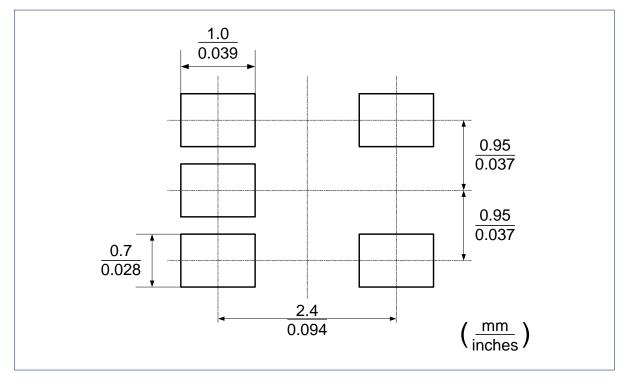
TAPE DIMENSIONS

Package Outlines

DIMENSIONS, S0T23-5L



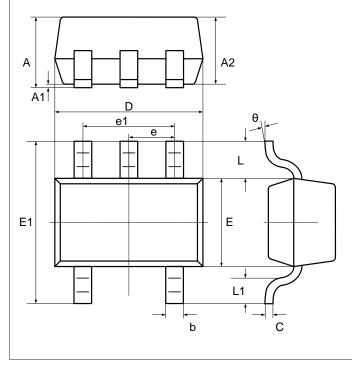
RECOMMENDED SOLDERING FOOTPRINT, SOT23-5L





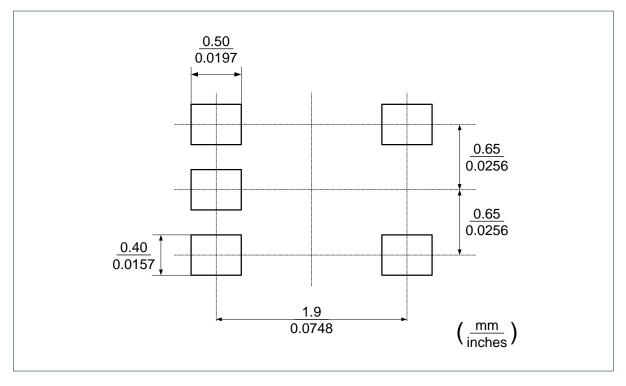
CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. Linearin and designs are registered trademarks of Linearin Technology Corporation. © Copyright Linearin Technology Corporation. All Rights Reserved.

DIMENSIONS, SC70-5L (SOT353)



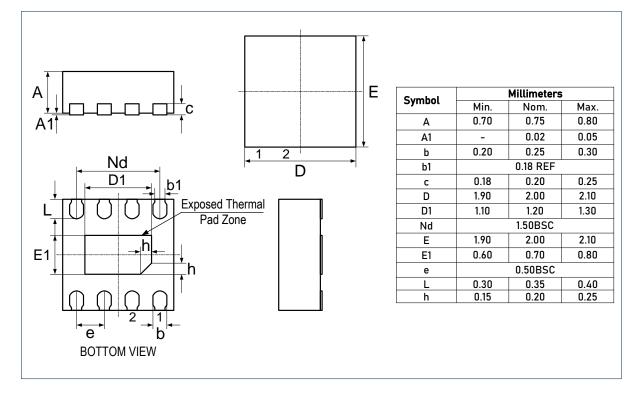
Symbol		nsions meters	Dimensions In Inches		
-	Min	Max	Min	Max	
A	0.90	1.10	0.035	0.043	
A1	0.00	0.10	0.000	0.004	
A2	0.90	1.00	0.035	0.039	
b	0.15	0.35	0.006	0.014	
С	0.08	0.15	0.003	0.006	
D	2.00	2.20	0.079	0.087	
E	1.15	1.35	0.045	0.053	
E1	2.15	2.45	0.085	0.096	
e	0.65	typ.	0.02	6 typ.	
e1	1.20	1.40	0.047	0.055	
L	0.52	5 ref.	ref. 0.021 ref.		
L1	0.26	0.46	0.010	0.018	
θ	0 °	8 °	0°	8°	

RECOMMENDED SOLDERING FOOTPRINT, SC70-5L (SOT353)

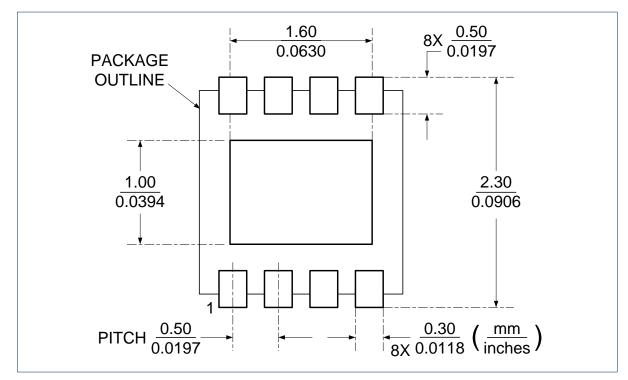




DIMENSIONS, DFN2x2-8L



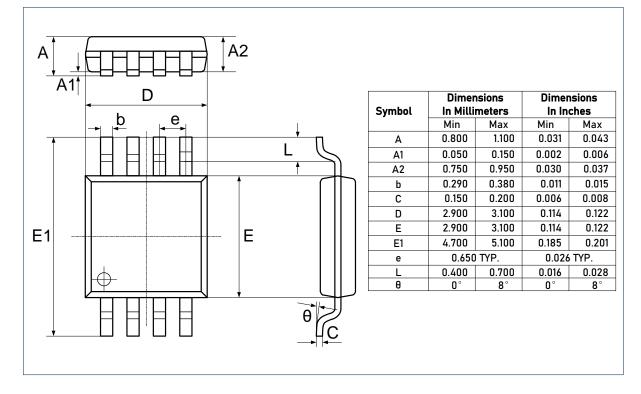
RECOMMENDED SOLDERING FOOTPRINT, DFN2x2-8L



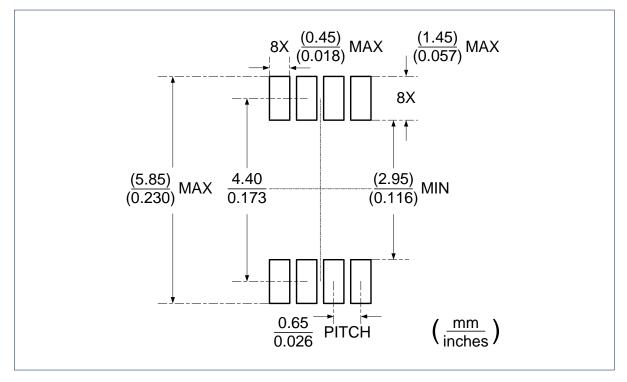
CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. Linearin and designs are registered trademarks of Linearin Technology Corporation. © Copyright Linearin Technology Corporation. All Rights Reserved.



DIMENSIONS, MSOP-8L



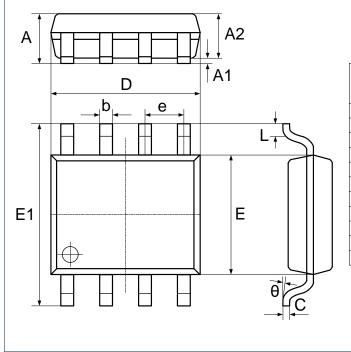
RECOMMENDED SOLDERING FOOTPRINT, MSOP-8L





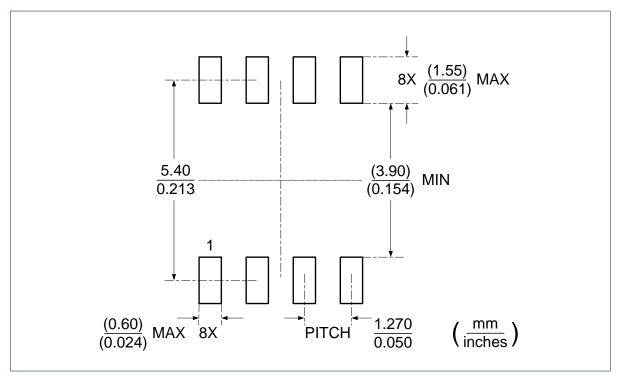
CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. Linearin and designs are registered trademarks of Linearin Technology Corporation. © Copyright Linearin Technology Corporation. All Rights Reserved.

DIMENSIONS, SOIC-8L



Symbol		nsions meters	Dimensions In Inches		
-	Min	Max	Min	Max	
А	1.370	1.670	0.054	0.066	
A1	0.070	0.170	0.003	0.007	
A2	1.300	1.500	0.051	0.059	
b	0.306	0.506	0.012	0.020	
С	0.203	TYP.	0.008 TYP.		
D	4.700	5.100	0.185	0.201	
E	3.820	4.020	0.150	0.158	
E1	5.800	6.200	0.228	0.244	
е	1.270	TYP.	0.050 TYP.		
L	0.450	0.750	0.018	0.030	
θ	0°	8°	0°	8°	

RECOMMENDED SOLDERING FOOTPRINT, SOIC-8L

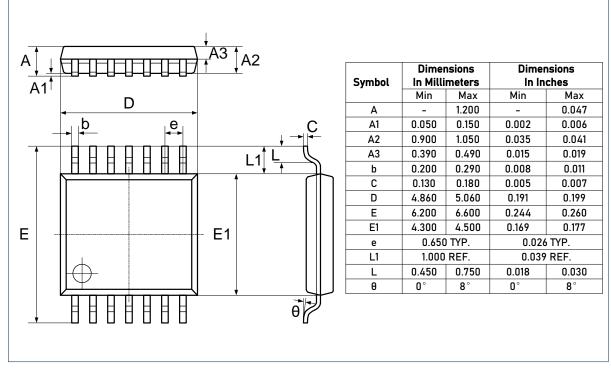


İNEARIN

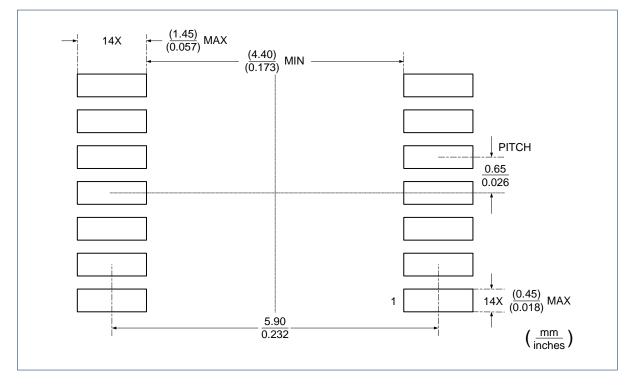
FN1617-35T.1 — Data Sheet

CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. Linearin and designs are registered trademarks of Linearin Technology Corporation. © Copyright Linearin Technology Corporation. All Rights Reserved.

DIMENSIONS, TSSOP-14L

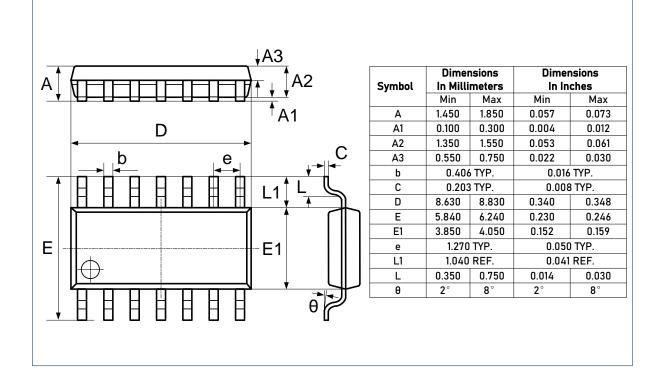


RECOMMENDED SOLDERING FOOTPRINT, TSSOP-14L

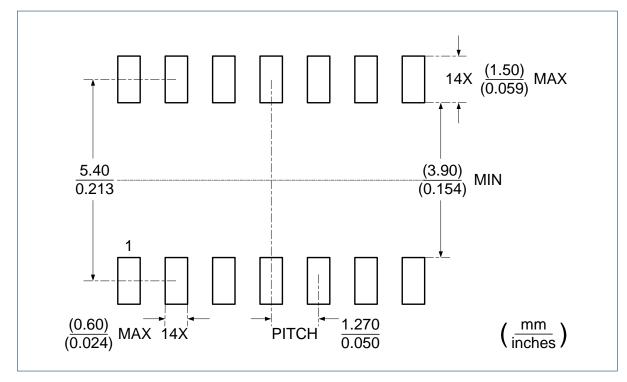




DIMENSIONS, SOIC-14L



RECOMMENDED SOLDERING FOOTPRINT, SOIC-14L



İNEARIN

CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. Linearin and designs are registered trademarks of Linearin Technology Corporation.

© Copyright Linearin Technology Corporation. All Rights Reserved. All other trademarks mentioned are the property of their respective owners.

LTC8825, LTC8826, LTC8828 Micropower 500kHz, Precision, 1.8V, RRIO CMOS Amplifiers

IMPORTANT NOTICE

Linearin is a global fabless semiconductor company specializing in advanced high-performance highquality analog/mixed-signal IC products and sensor solutions. The company is devoted to the innovation of high performance, analog-intensive sensor front-end products and modular sensor solutions, applied in multi-market of medical & wearable devices, smart home, sensing of IoT, and intelligent industrial & smart factory (industrie 4.0). Linearin's product families include widely-used standard catalog products, solution-based application specific standard products (ASSPs) and sensor modules that help customers achieve faster time-to-market products. Go to <u>http://www.linearin.com</u> for a complete list of Linearin product families.

For additional product information, or full datasheet, please contact with the Linearin's Sales Department or Representatives.

